



芯科半导体

ELECTRONIC
PRODUCT
浙江芯科半导体有限公司

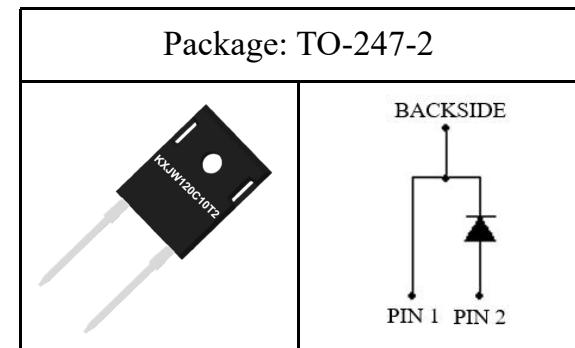
Features

- ✓ Zero forward recovery voltage
- ✓ Zero reverse recovery current
- ✓ Excellent surge current capability
- ✓ Temperature independent switching
- ✓ Positive temperature coefficient on V_F
- ✓ High frequency operation

Part NO.	KXJW120C10T2
V_{RRM}	= 1200 V
$I_F(T_C=150^\circ C)$	= 10 A
Q_C	= 52 nC

Applications

- ✓ Motor drives
- ✓ Uninterruptible power supplies
- ✓ Photovoltaic inverter
- ✓ Switch mode power supplies (SMPS)



Key performance parameters

Symbol	Parameter	Test conditions	Value	Unit	Note
V_{RRM}	Repetitive peak reverse voltage	$T_C = 25^\circ C$	1200	V	
V_{RSM}	Surge peak reverse voltage (DC)	$T_C = 25^\circ C$	1200	V	
I_F	Continuous forward current	$T_C = 25^\circ C, D=1$ $T_C = 140^\circ C, D=1$ $T_C = 150^\circ C, D=1$	32 14.8 10	A	Fig.2
I_{FRM}	Repetitive forward surge current	$t_p = 10 \text{ ms}, \text{Half sine wave}$ $T_C = 25^\circ C$ $T_C = 150^\circ C$	42 21	A	
I_{FSM}	Non-repetitive forward surge current	$t_p = 10 \text{ ms}, \text{Half sine wave}$ $T_C = 25^\circ C$ $T_C = 150^\circ C$	98 75	A	
$\int i^2 dt$	$i^2 t$ value	$T_C = 25^\circ C, t_p = 10 \text{ ms}$	48	$A^2 s$	
P_{tot}	Total power dissipation	$T_C = 25^\circ C$	154	W	Fig.1
T_j	Operating junction temperature		-55 ~ 175	$^\circ C$	
T_{stg}	Storage temperature		-55 ~ 175	$^\circ C$	

Static electrical characteristics

Symbol	Parameter	Test conditions	Value			Unit	Note
			Min.	Typ.	Max.		
V _{DC}	DC blocking voltage	I _R = 500 μA, T _j = 25°C	1200	-	-	V	
V _F	Diode forward voltage	I _F = 10 A, T _j = 25°C I _F = 10 A, T _j = 150°C	1.41 1.8	1.5 2.2	1.59 2.2	V	Fig.3
I _R	Reverse current	V _R = 1200 V, T _j = 25°C V _R = 1200 V, T _j = 150°C	- -	20 50	100 200	μA	Fig.4
C	Total capacitance	V _R = 0.1 V, T _j = 25°C, f= 1 MHz V _R = 400 V, T _j = 25°C, f= 1 MHz V _R = 800 V, T _j = 25°C, f= 1 MHz	-	694 49 37	-	pF	Fig.8
Q _C	Total capacitive charge	V _R = 800 V, T _j = 25°C	-	52	-	nC	Fig.5
E _C	Capacitance stored energy	V _R = 800 V, T _j = 25°C	-	16	-	μJ	Fig.7

Thermal characteristics

Symbol	Parameter	Value		Unit	Note
		Typ	Max		
R _{θJC}	Thermal resistance from junction to case	0.88	1.2	°C/W	Fig.6

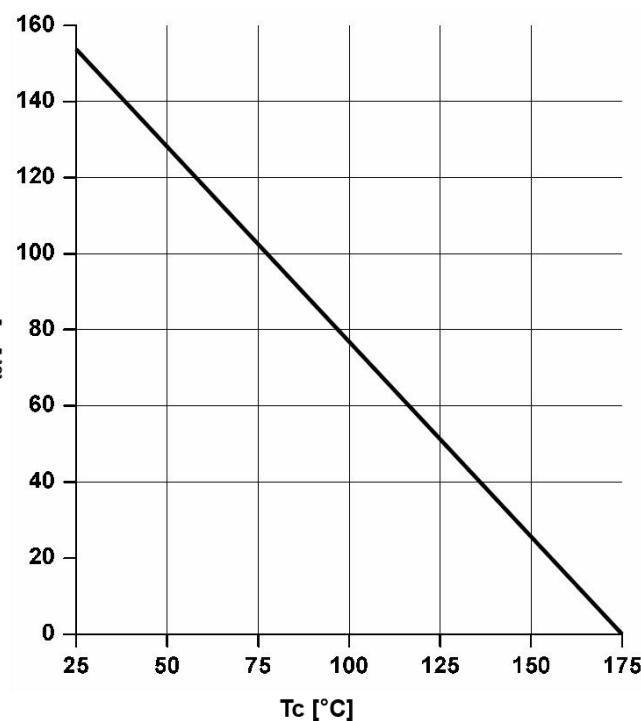


Figure.1 Power dissipation

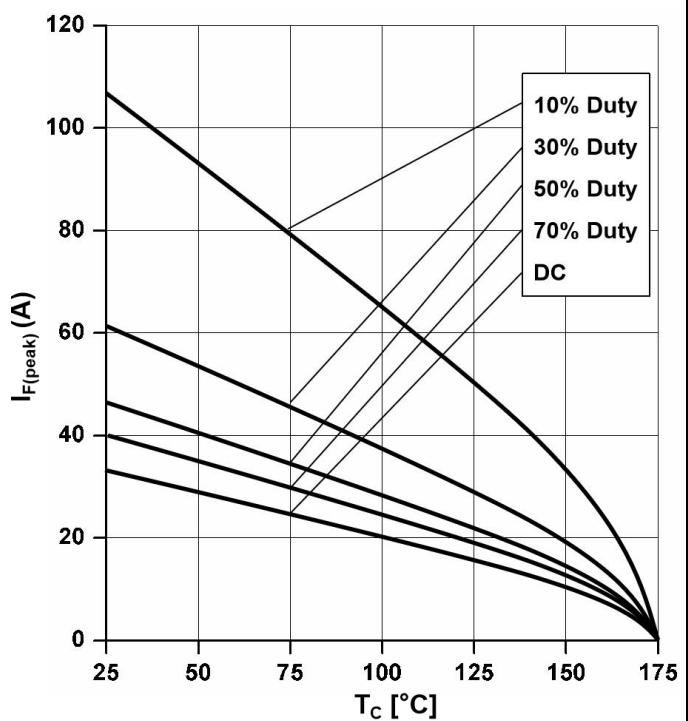


Figure.2 Diode forward current

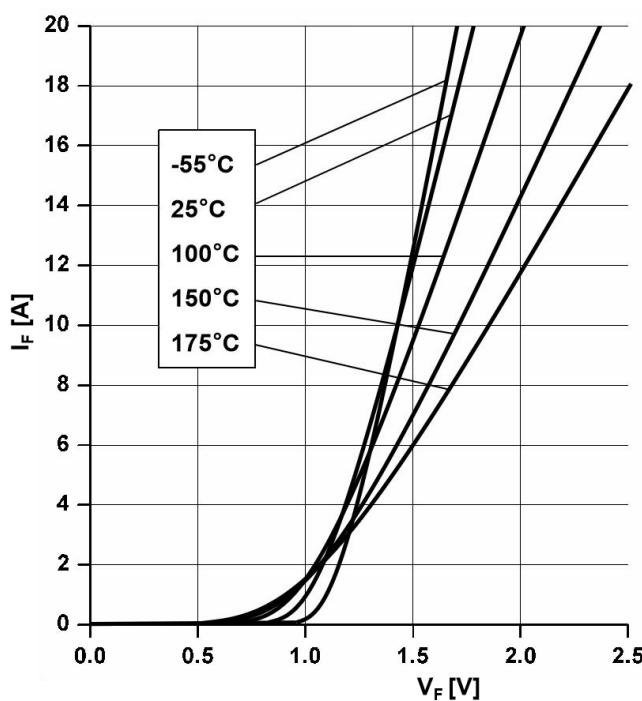


Figure.3 Typical forward characteristics

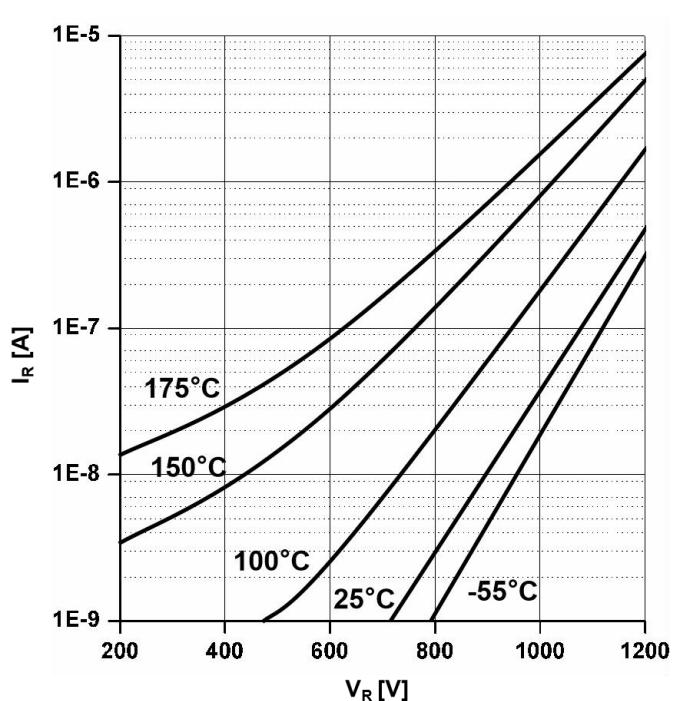


Figure.4 Reverse current vs. reverse voltage



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SiC Schottky Diode #KXJW120C10T2

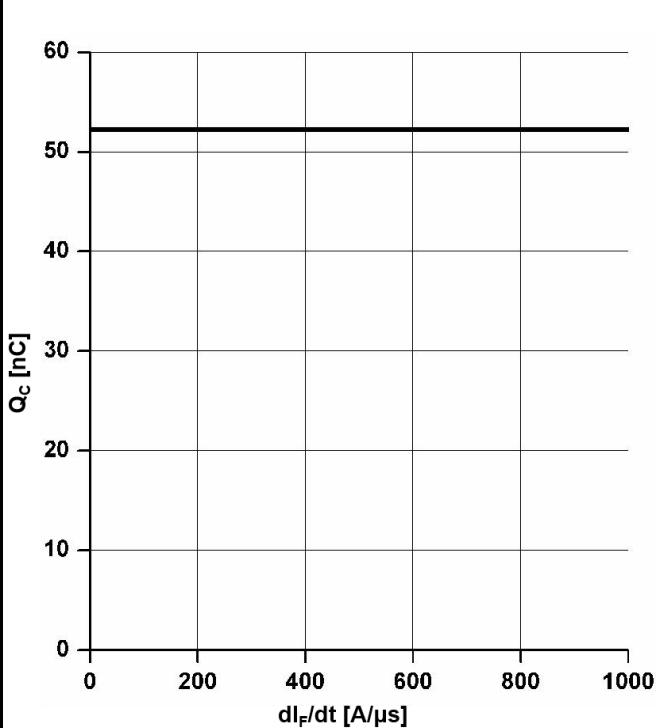


Figure.5 Capacitance charge vs. current slope

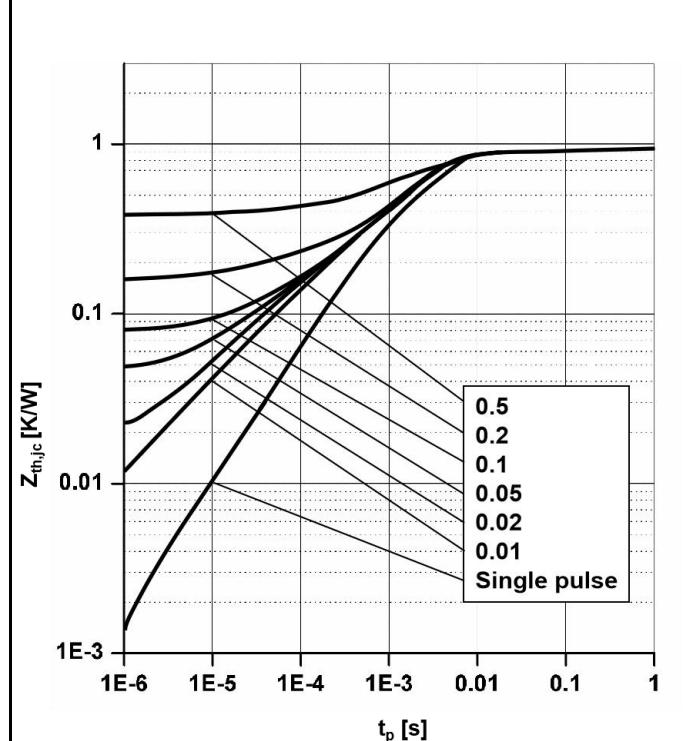


Figure.6 Transient thermal impedance

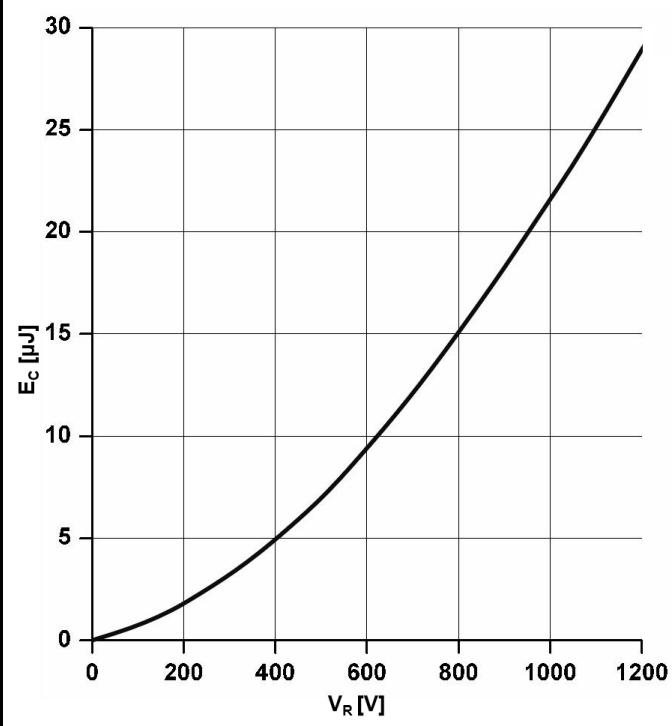


Figure.7 Capacitance stored energy

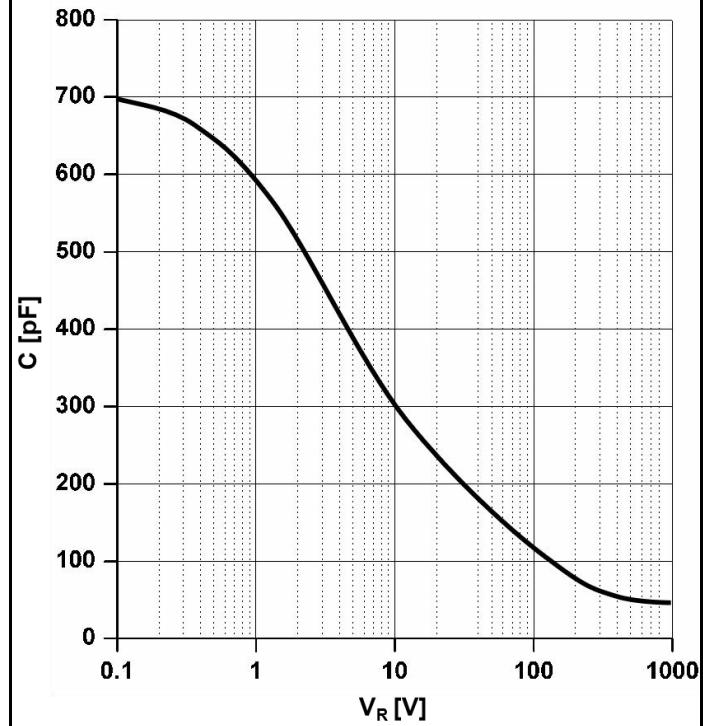
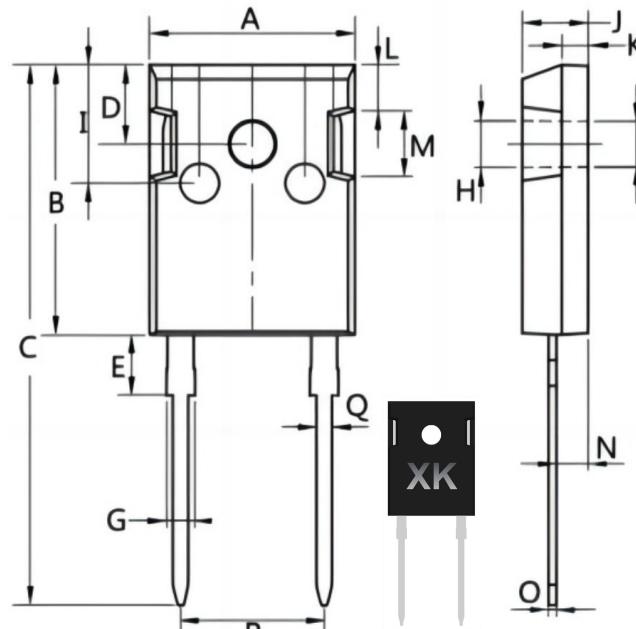


Figure.8 Capacitance vs. reverse voltage



Package outlines



Dim.	Min.	Max.
A	15.0	16.0
B	20.0	21.0
C	40.0	42.0
D	5.5	6.5
E	4.0	5.5
G	1.75	2.5
H	3.0	4.0
I	8.0	10.0
J	4.9	5.1
K	1.9	2.1
L	3.0	4.0
M	4.75	5.25
N	2.0	3.0
O	0.55	0.65
P	Typ 10.8	
Q	1.2	1.3

All Dimensions in millimeter